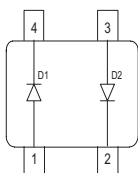


Silicon Schottky Diode

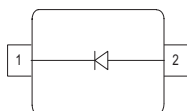
- Low barrier diode for detectors up to GHz frequencies
- Pb-free (RoHS compliant) package



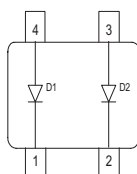
BAT62



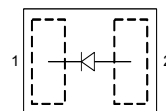
BAT62-02W BAT62-03W



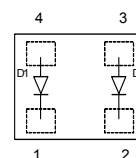
BAT62-07W



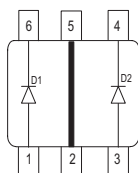
BAT62-02L BAT62-02LS



BAT62-07L4



BAT62-09s



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Package	Configuration	L_S (nH)	Marking
BAT62	SOT143	anti-parallel pair	2	62s
BAT62-02L	TSLP-2-1	single, leadless	0.4	L
BAT62-02LS*	TSSLP-2-1	single, leadless	0.2	U
BAT62-02W	SCD80	single	0.6	62
BAT62-03W	SOD323	single	1.8	white L
BAT62-07L4	TSLP-4-4	parallel pair, leadless	0.4	62
BAT62-07W	SOT343	parallel pair	1.8	62s
BAT62-09s	SOT363	parallel high, high isolation	1.6	69s

* Preliminary Data

Maximum Ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	40	V
Forward current	I_F	20	mA
Total power dissipation BAT62, $T_S \leq 85^\circ\text{C}$ BAT62-02L, -07L4, -03W, $T_S \leq 108^\circ\text{C}$ BAT62-02W, $T_S \leq 109^\circ\text{C}$ BAT62-07W, $T_S \leq 103^\circ\text{C}$ BAT62-09S, $T_S \leq 105^\circ\text{C}$	P_{tot}	100 100 100 100 100	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾ BAT62 BAT62-02L, -07L4, -03W BAT62-02W BAT62-07W BAT62-09S	R_{thJS}	≤ 650 ≤ 420 ≤ 410 ≤ 470 $\leq \text{td}$	K/W

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse current $V_R = 40\text{ V}$	I_R	-	-	10	μA
Forward voltage $I_F = 2\text{ mA}$	V_F	-	0.58	1	V
Forward voltage matching ²⁾ $I_F = 2\text{ mA}$	ΔV_F	-	-	20	mV

¹⁾For calculation of R_{thJA} please refer to Application Note Thermal Resistance

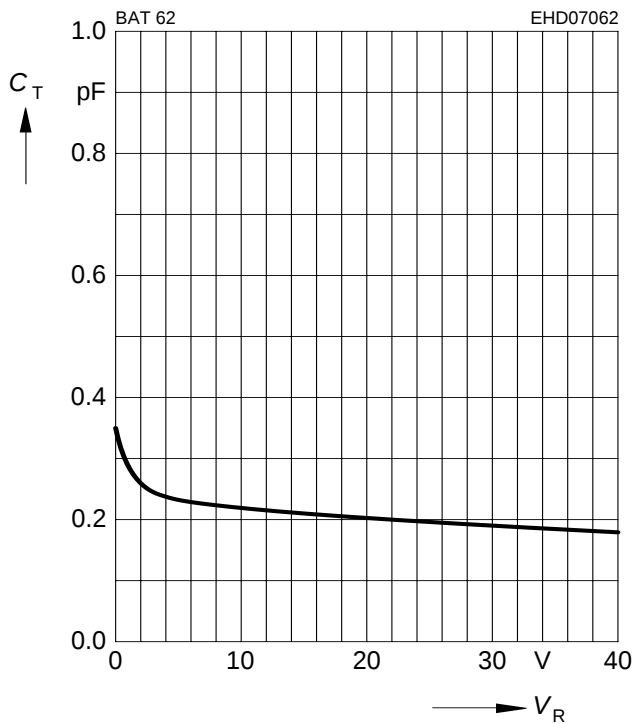
²⁾ ΔV_F is the difference between lowest and highest V_F in a multiple diode component.

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Diode capacitance $V_R = 0\text{ V}, f = 1\text{ MHz}$	C_T	-	0.35	0.6	pF
Differential resistance $V_R = 0\text{ V}, f = 10\text{ kHz}$	R_0	-	225	-	kΩ

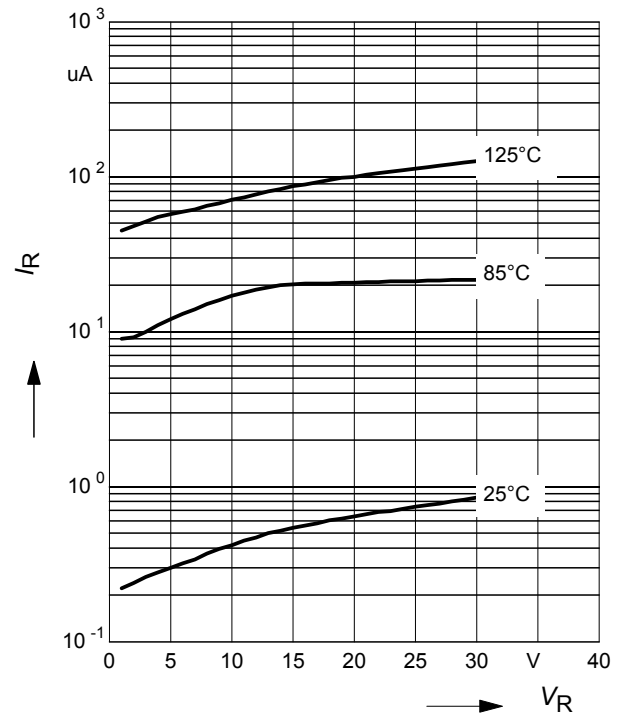
Diode capacitance $C_T = f(V_R)$

$f = 1\text{MHz}$



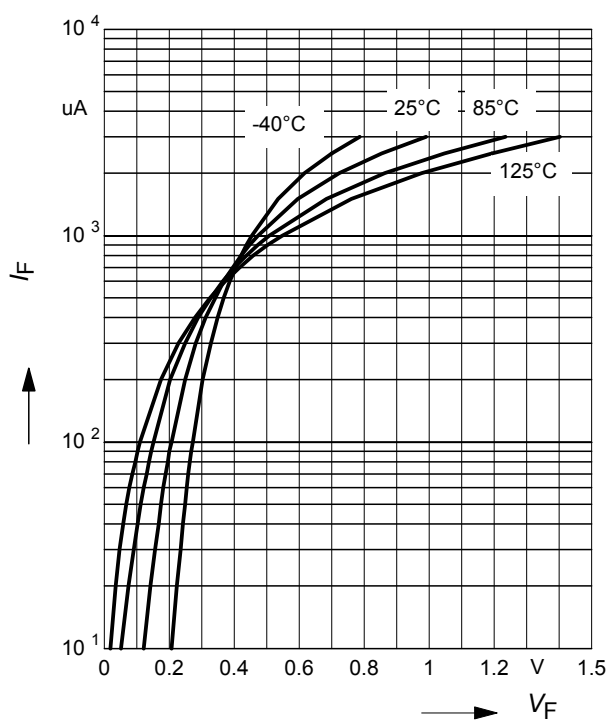
Reverse current $I_R = f(V_R)$

$T_A = \text{Parameter}$



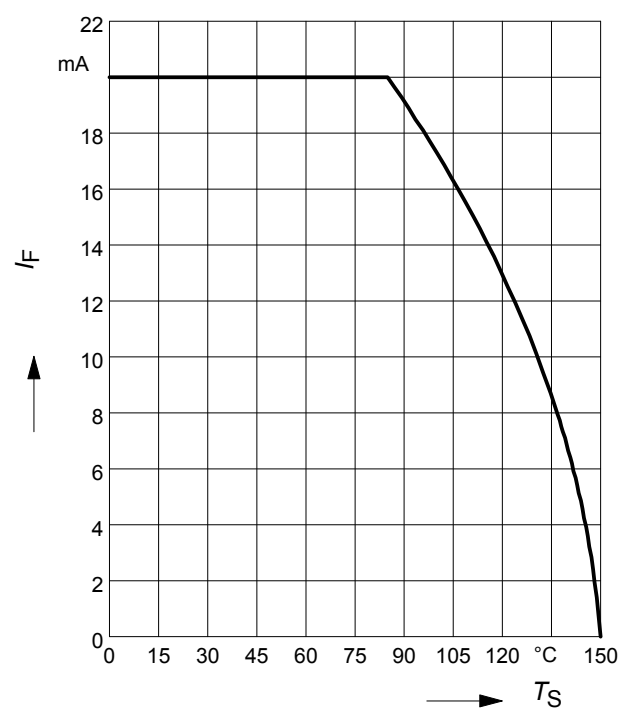
Forward current $I_F = f(V_F)$

$T_A = \text{Parameter}$



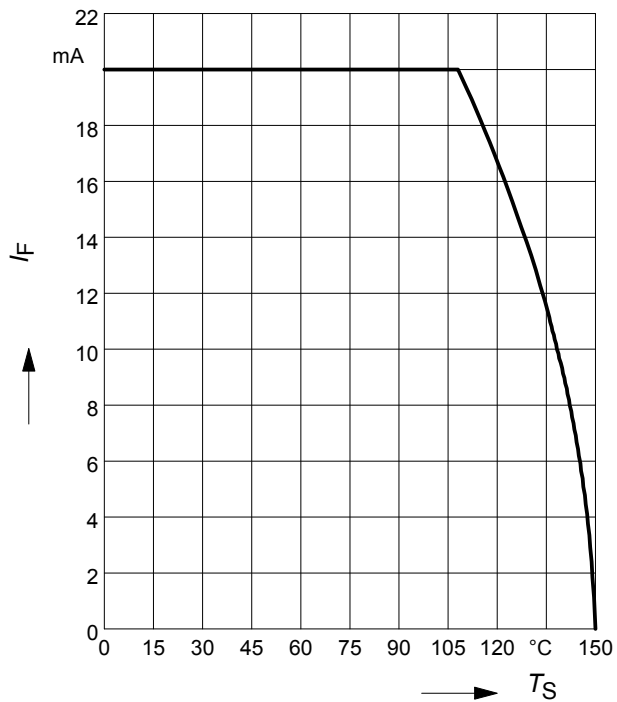
Forward current $I_F = f(T_S)$

BAT62



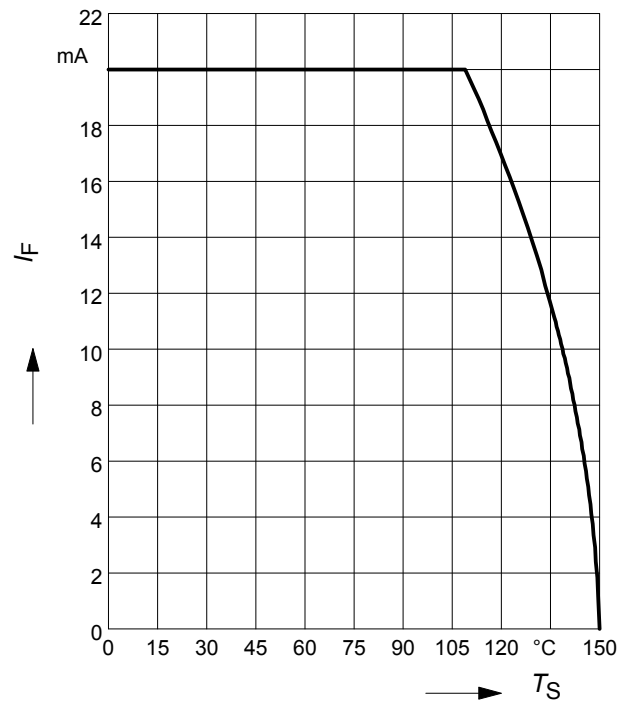
Forward current $I_F = f(T_S)$

BAT62-02L, -07L4



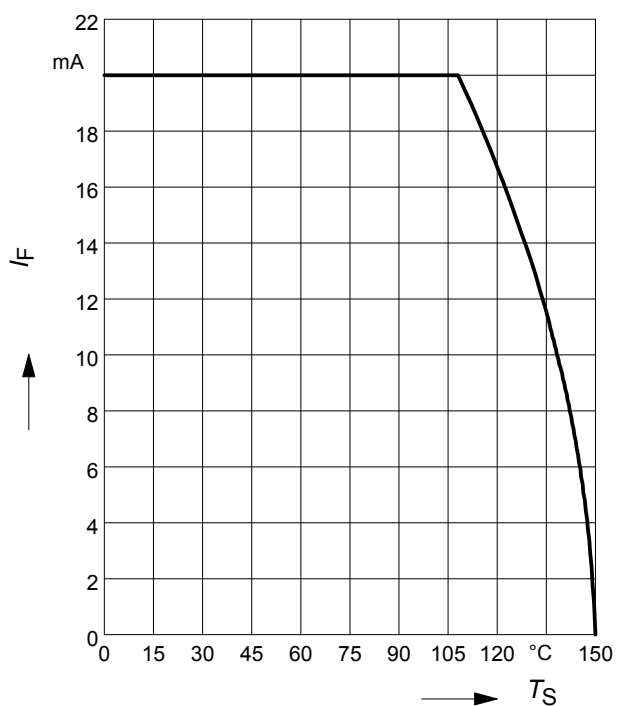
Forward current $I_F = f(T_S)$

BAT62-02W



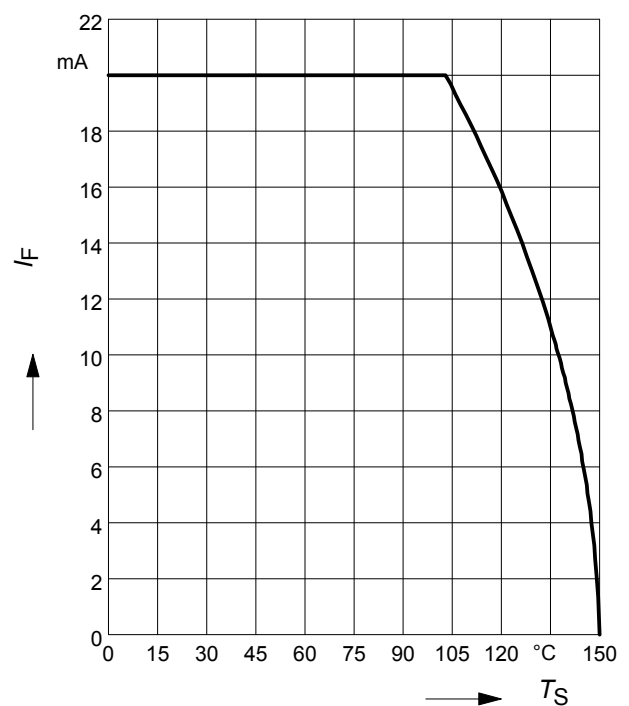
Forward current $I_F = f(T_S)$

BAT62-03W



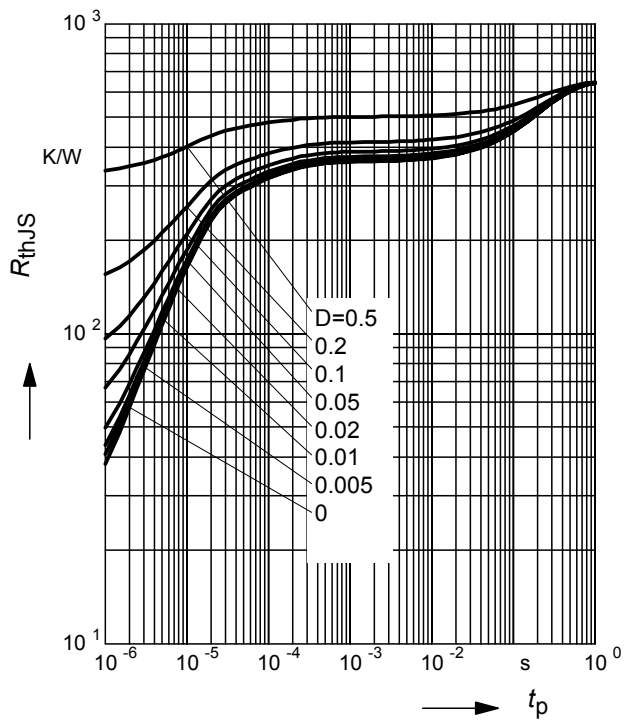
Forward current $I_F = f(T_S)$

BAT62-07W



Permissible Puls Load $R_{thJS} = f(t_p)$

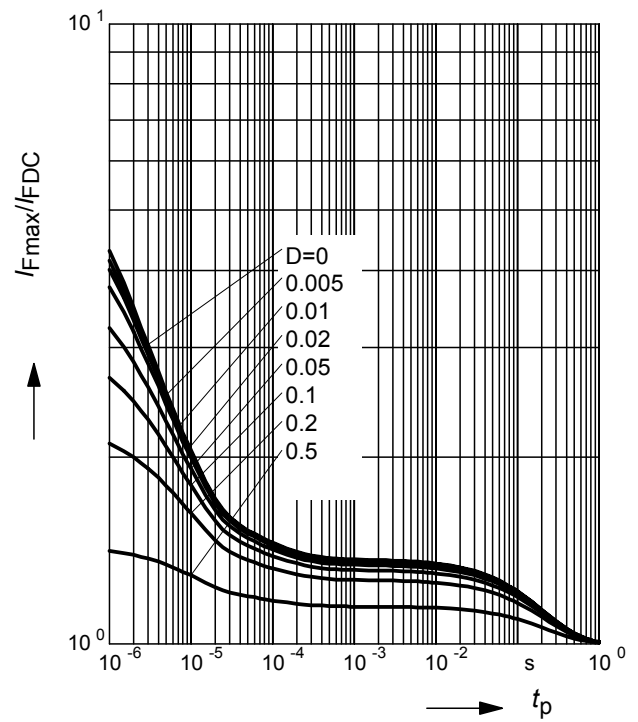
BAT62



Permissible Pulse Load

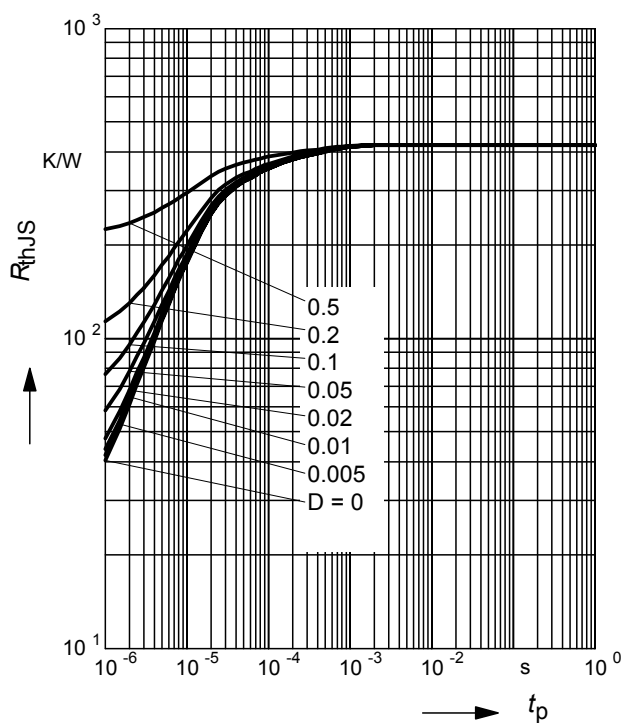
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62



Permissible Puls Load $R_{thJS} = f(t_p)$

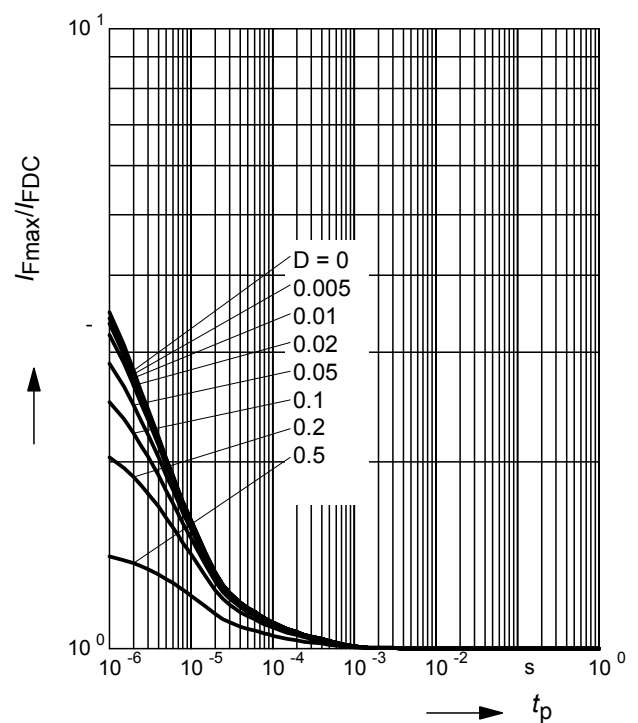
BAT62-02L, -07L4



Permissible Pulse Load

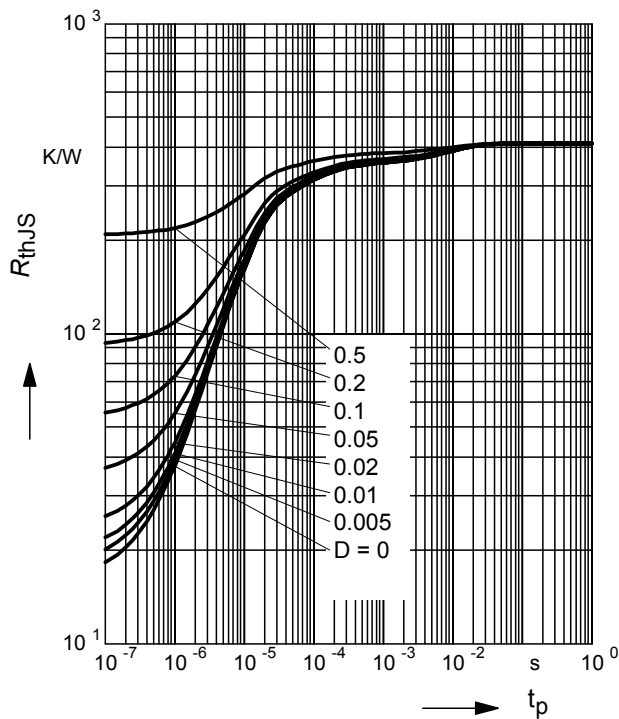
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62-02L, -07L4



Permissible Puls Load $R_{thJS} = f(t_p)$

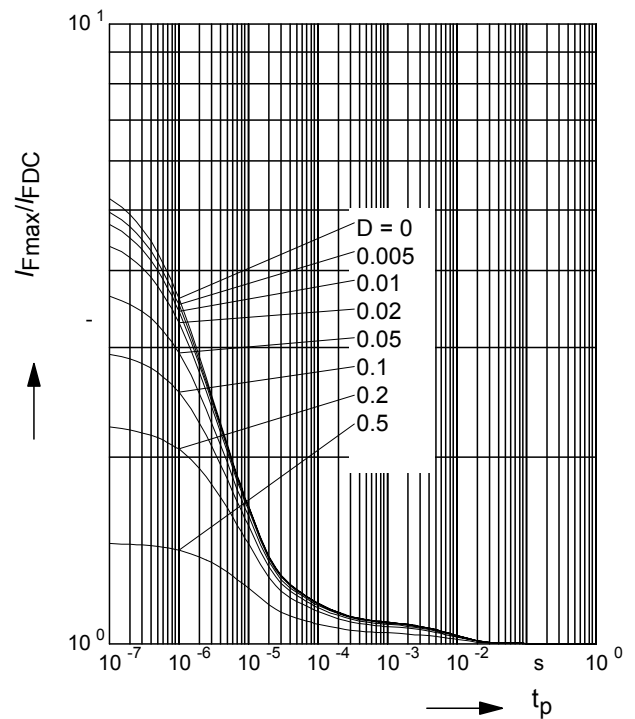
BAT62-02W



Permissible Pulse Load

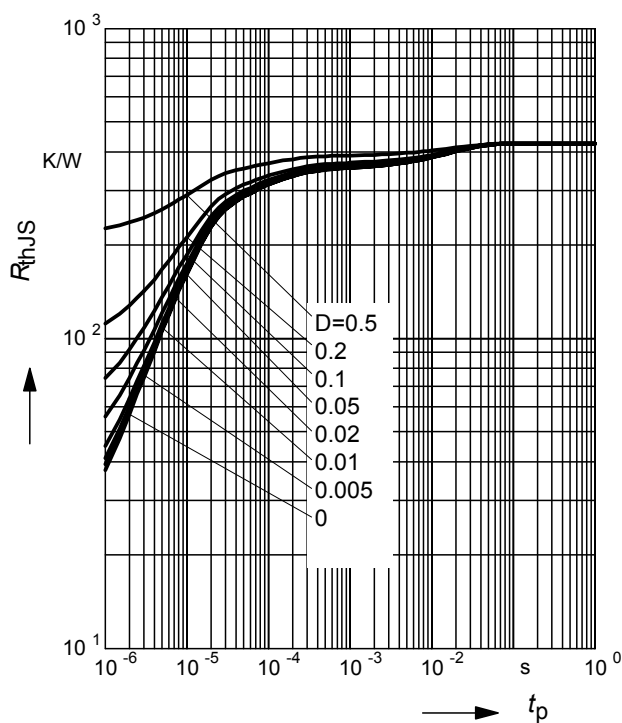
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62-02W



Permissible Puls Load $R_{thJS} = f(t_p)$

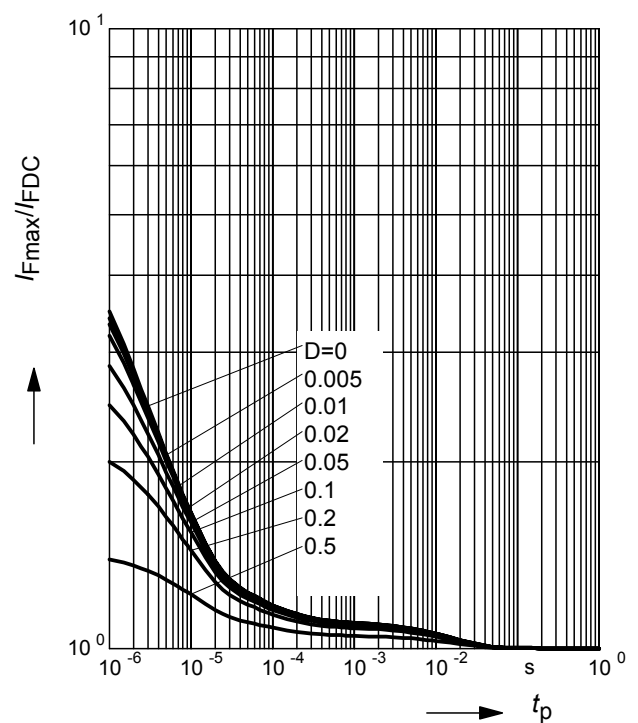
BAT62-03W



Permissible Pulse Load

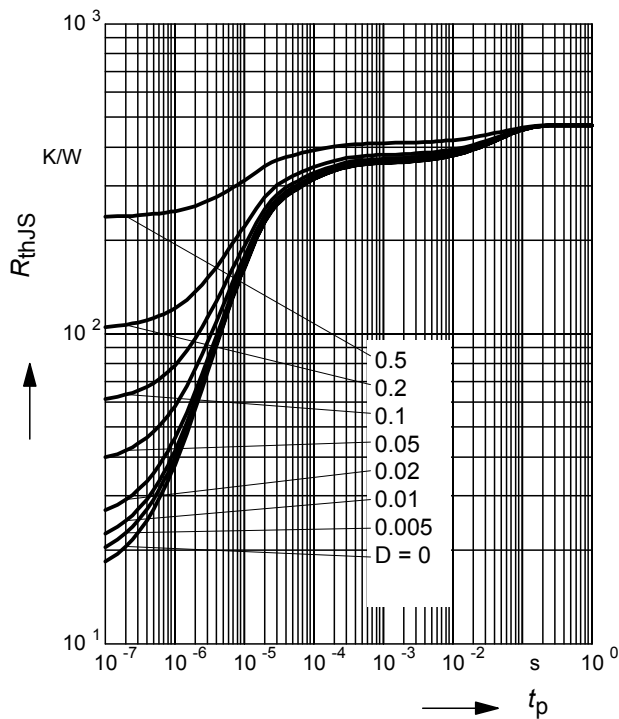
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62-03W



Permissible Puls Load $R_{thJS} = f(t_p)$

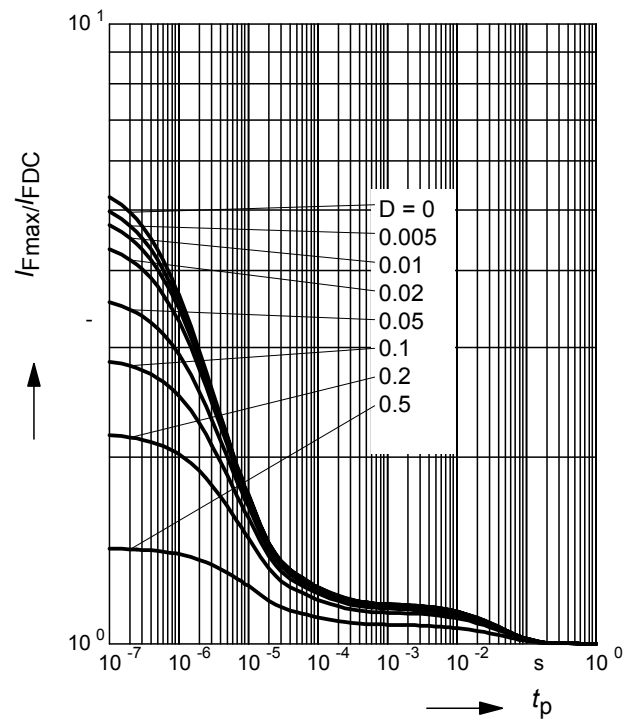
BAT62-07W



Permissible Pulse Load

$$I_{Fmax}/I_{FDC} = f(t_p)$$

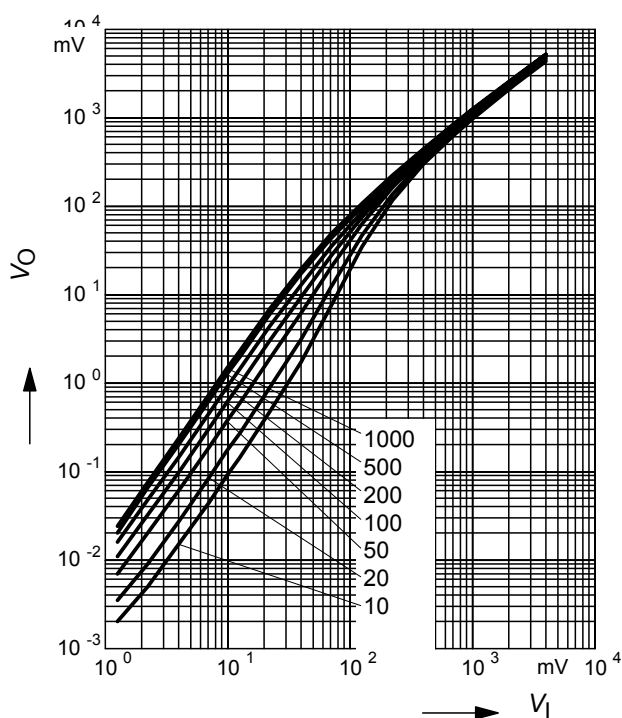
BAT62-07W



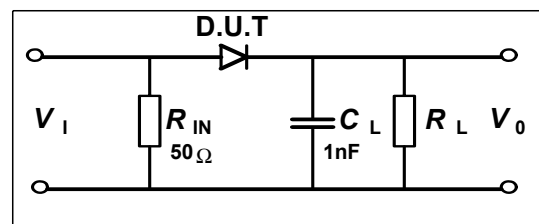
Rectifier voltage $V_{out} = f(V_{in})$

$f = 900\text{MHz}$

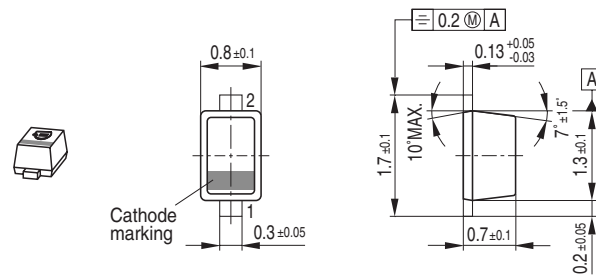
$R_L = \text{Parameter in k}\Omega$



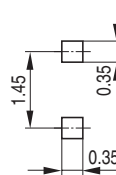
Testcircuit



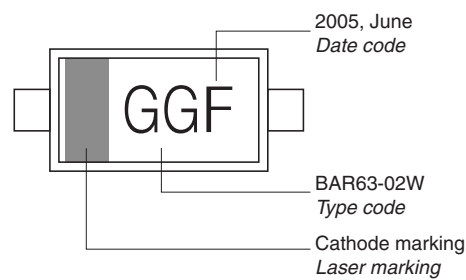
Package Outline



Foot Print

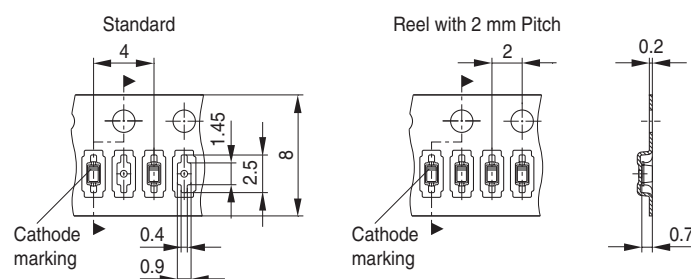


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel



Date Code marking for discrete packages with one digit (SCD80, SC79, SC75¹⁾) CES-Code

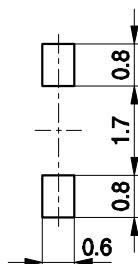
Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

1) New Marking Layout for SC75, implemented at October 2005.

Package Outline



Foot Print



Marking Layout (Example)



Standard Packing

Reel $\varnothing 180 \text{ mm}$ = 3.000 Pieces/Reel
 Reel $\varnothing 330 \text{ mm}$ = 10.000 Pieces/Reel



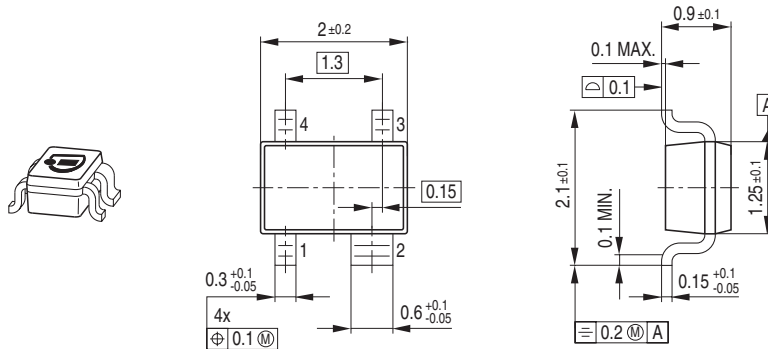
Diagram illustrating the marking on the BFP181 package:

- Manufacturer:** infineon
- Date code (YM):** 2005, June
- Pin 1:** Indicated by a line pointing to the first pin on the left.
- Type code:** BFP181

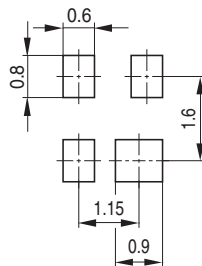
Technical drawing of a mechanical part showing top and side views with dimensions:

- Top View Dimensions:**
 - Overall width: 4
 - Overall height: 8
 - Distance from left edge to first hole center: 3.15
 - Distance between hole centers: 2.6
 - Distance from last hole center to right edge: 2.6
- Side View Dimensions:**
 - Overall thickness: 0.2
 - Distance from bottom edge to hole center: 1.15
- Other Features:**
 - Three circular holes are shown in the top view.
 - A rectangular feature labeled "Pin 1" is located on the left side.
 - Section lines (hatching) are used to indicate the cross-section in the side view.

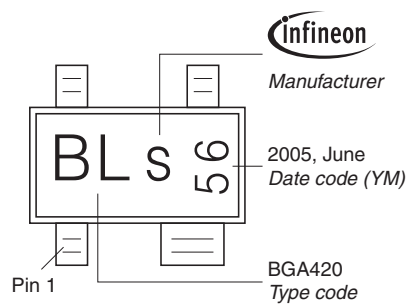
Package Outline



Foot Print

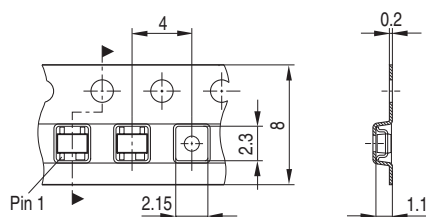


Marking Layout (Example)

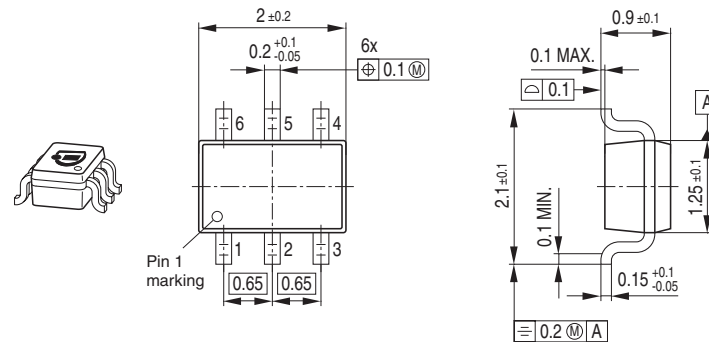


Standard Packing

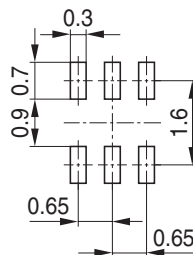
Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø330 mm = 10.000 Pieces/Reel



Package Outline

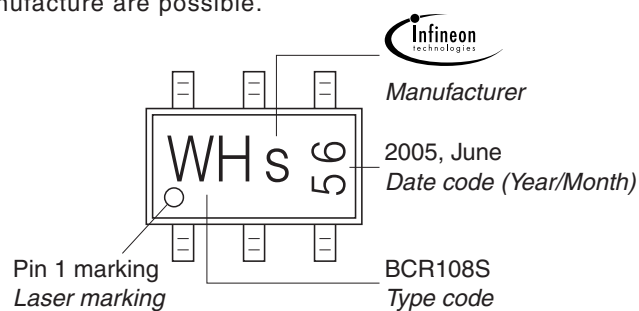


Foot Print



Marking Layout (Example)

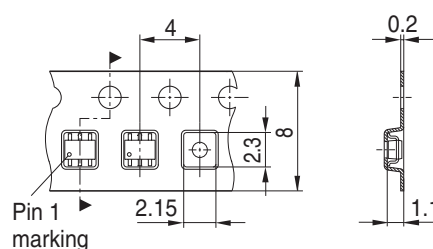
Small variations in positioning of Date code, Type code and Manufacture are possible.



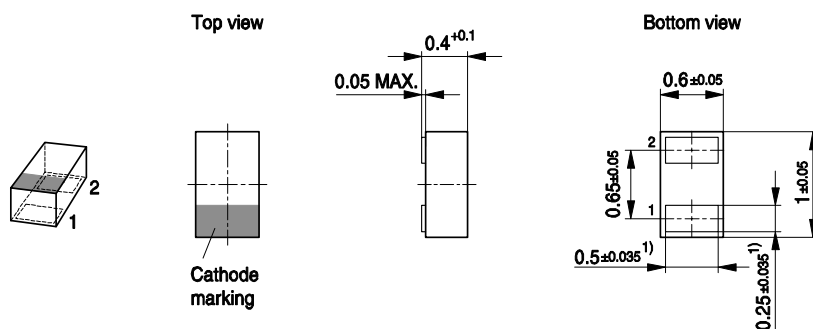
Standard Packing

Reel $\varnothing 180$ mm = 3.000 Pieces/Reel
Reel $\varnothing 330$ mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



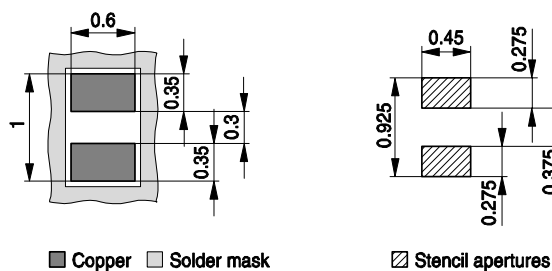
Package Outline



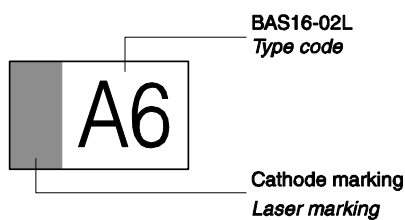
1) Dimension applies to plated terminal

Foot Print

For board assembly information please refer to Infineon website "Packages"



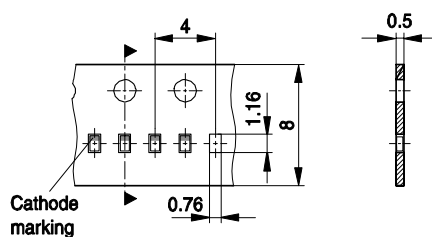
Marking Layout (Example)



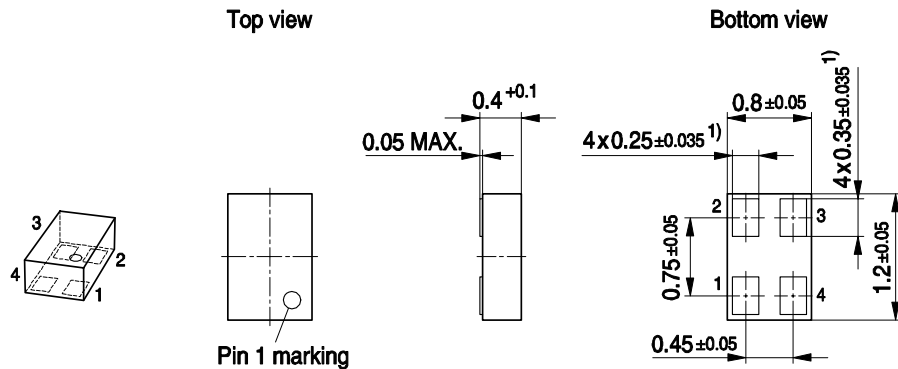
Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel

Reel ø330 mm = 50.000 Pieces/Reel (optional)



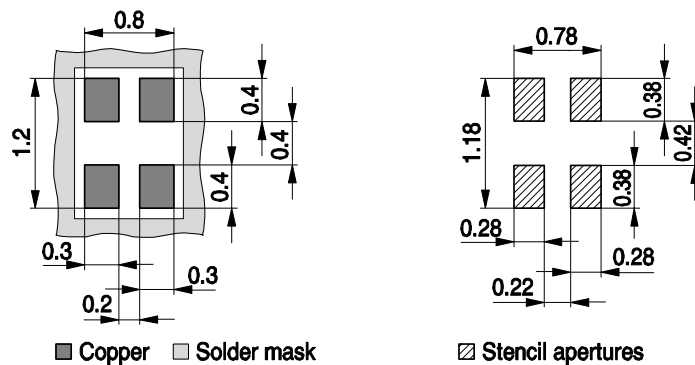
Package Outline



1) Dimension applies to plated terminal

Foot Print

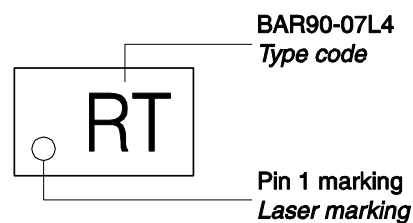
For board assembly information please refer to Infineon website "Packages"



■ Copper □ Solder mask

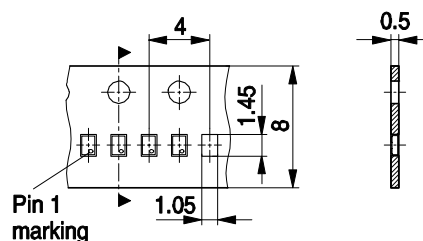
▨ Stencil apertures

Marking Layout (Example)

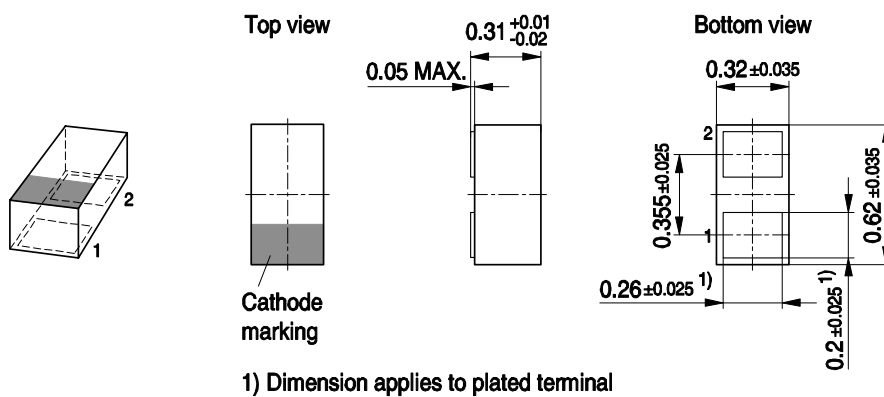


Standard Packing

Reel $\varnothing 180 \text{ mm}$ = 15.000 Pieces/Reel

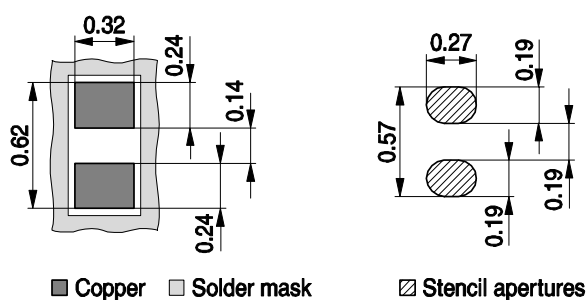


Package Outline

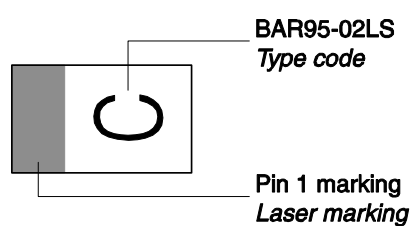


Foot Print

For board assembly information please refer to Infineon website "Packages"

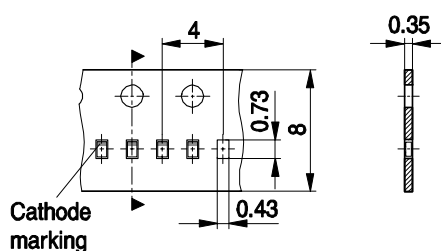


Marking Layout (Example)



Standard Packing

Reel $\varnothing 180$ mm = 15.000 Pieces/Reel



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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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